Silicon Carbide Schottky Diode

650 V, 10 A

FFSM1065B

Description

Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size & cost.

Features

- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Peak Repetitive Reverse Voltage		V_{RRM}	650	V
Single Pulse Avalanche Energy (starting T _J = 25°C, I _{AS} = 14 A, L = 0.5 mH, V = 50 V)		E _{AS}	49	mJ
Continuous Rectified Forward Current	T _C < 150	IF	10	Α
Current	T _C < 135		13.5	
Non-Repetitive Peak Forward	T _C = 25°C	I _{FM}	532	Α
Surge Current (t _P = 10 μs)	T _C = 150°C		468	
Non-Repetitive Forward Surge Current (Half-Sine Pulse)	$T_{C} = 25^{\circ}C$ $t_{P} = 8.3 \text{ ms}$	I _{FSM}	42	Α
Power Dissipation	T _C = 25°C	P _{tot}	98	W
	T _C = 150°C		16	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE

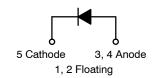
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, Max	$R_{\theta JC}$	1.53	°C/W



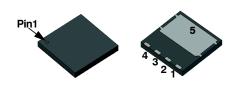
ON Semiconductor®

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V _{RRM}	I _F	
650 V	10 A	



Schottky Diode



PQFN 8×8, 2P CASE 483AP

MARKING DIAGRAM

9 \$Y FFSM 1065B &Z&K&3

\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &K = Lot Code &3 = Numeric Date Code

FFSM1065B = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_J = 25^{\circ}C \ unless \ otherwise \ noted)$

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 10 A, T _J = 25°C	_	1.38	1.7	V
		I _F = 10 A, T _J = 125°C	_	1.6		
		I _F = 10 A, T _J = 150°C	=	1.67		
I _R	Reverse Current	V _R = 650 V, T _J = 25°C	=	0.5	40	μΑ
		V _R = 650 V, T _J = 125°C	=	1	80	
		V _R = 650 V, T _J = 175°C	-	2	160	
Q_{C}	Total Capacitive Charge	V = 400 V	=	25	=	nC
С	Total Capacitance	V _R = 1 V, f = 100 kHz	-	424	-	pF
		V _R = 300 V, f = 100 kHz	-	39	-	
		V _R = 600 V, f = 100 kHz	=	35	=	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping*
FFSM1065B	FFSM1065B	PQFN 8X8, 2P (Halogen Free)	3000 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D

TYPICAL CHARACTERISTICS

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

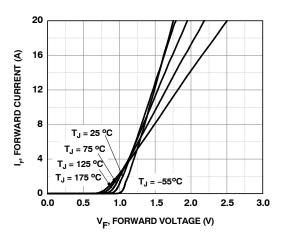


Figure 1. Forward Characteristics

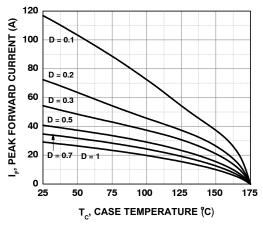


Figure 3. Current Derating

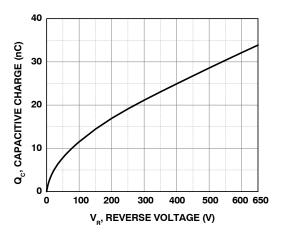


Figure 5. Capacitive Charge vs. Reverse Voltage

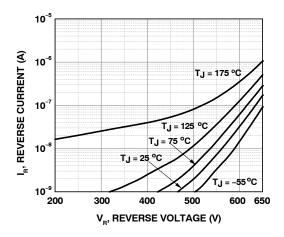


Figure 2. Reverse Characteristics

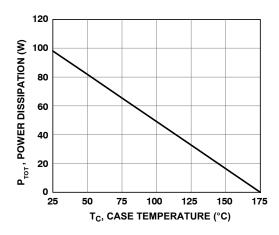


Figure 4. Power Derating

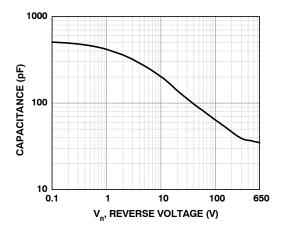


Figure 6. Capacitance vs. Reverse Voltage

TYPICAL CHARACTERISTICS (continued)

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

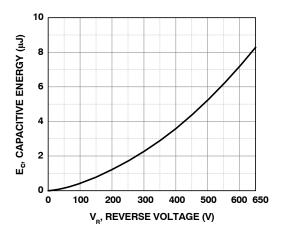


Figure 7. Capacitance Stored Energy

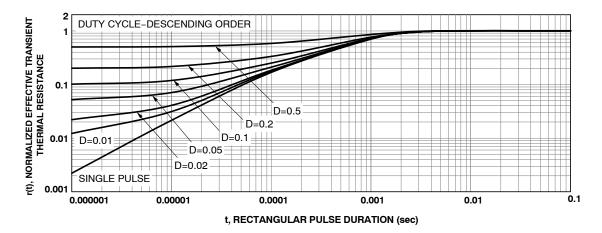
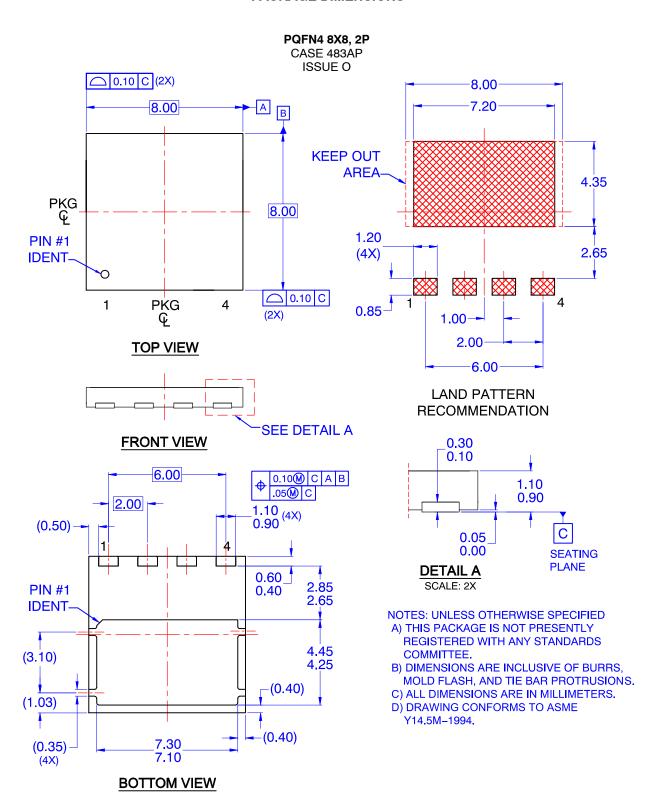


Figure 8. Junction-to-Case Transient Thermal Response Curve

PACKAGE DIMENSIONS



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